



80V 175°C N-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D Tc = +25°C (Note 11)
80V	$4m\Omega$ @ $V_{GS} = 10V$	100A

Description and Applications

This new generation MOSFET is designed to minimize $R_{DS(ON)}$, yet maintain superior switching performance. This device is ideal for use in power management and load switch.

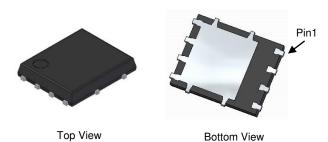
- DC-DC Converters
- Load Switch

Features

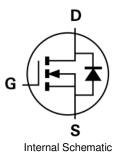
- Rated to +175°C Ideal for High Ambient Temperature Environments
- 100% Unclamped Inductive Switching (UIS) Test in Production Ensures More Reliable and Robust End Application
- High Conversion Efficiency
- Low R_{DS(ON)} Minimizes On State Losses
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

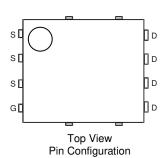
Mechanical Data

- Case: PowerDI[®]5060-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections: See Diagram Below
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)



PowerDI5060-8





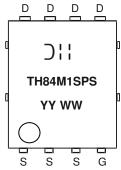
Ordering Information (Note 4)

Part Number	Case	Packaging
DMTH84M1SPS-13	PowerDI5060-8	2,500 / Tape & Reel

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/

Marking Information



⊃¦¦= Manufacturer's Marking TH84M1SPS = Product Type Marking Code YYWW = Date Code Marking YY = Year (ex: 19 = 2019) WW = Week (01 to 53)

PowerDI is a registered trademark of Diodes Incorporated.



Maximum Ratings (@T_C = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage	V_{DSS}	80	V		
Gate-Source Voltage	Vgss	±20	V		
Continuous Drain Current, V _{GS} = 10V (Note 7)	Steady State	$T_{C} = +25^{\circ}C$ $T_{C} = +100^{\circ}C$ (Note 11)	ΙD	100 100	А
Maximum Continuous Body Diode Forward Current (Not	Is	83	Α		
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)	IDM	400	Α		
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	400	Α
Avalanche Current, L = 1mH (Note 8)			las	23	Α
Avalanche Energy, L = 1mH (Note 8)			Eas	264.5	mJ

Thermal Characteristics (@Tc = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	P_D	1.6	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	RθJA	96	°C/W
Total Power Dissipation (Note 6)	T _A = +25°C	PD	2.8	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	RθJA	53	°C/W
Total Power Dissipation (Note 7)	T _C = +25°C	P _D	136	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	1.1	°C/W
Operating and Storage Temperature Range		T _{J,} T _{STG}	-55 to +175	°C

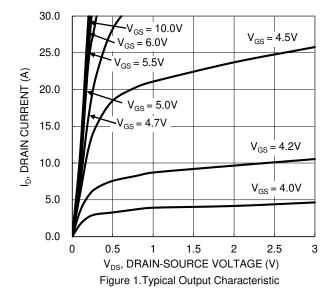
Electrical Characteristics (@T_C = +25°C, unless otherwise specified.)

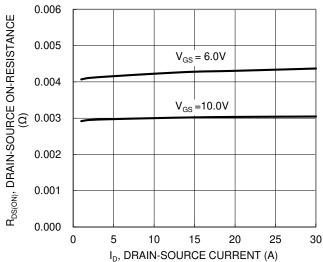
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	80	_	_	V	$V_{GS} = 0V$, $I_D = 1mA$	
Zero Gate Voltage Drain Current	IDSS	_	_	1	μΑ	$V_{DS} = 64V$, $V_{GS} = 0V$	
Gate-Source Leakage	Igss		_	±100	nA	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	V _{GS(TH)}	2	_	4	V	$V_{DS} = V_{GS}$, $I_D = 250\mu A$	
Static Drain-Source On-Resistance		_	3.1	4	mΩ	$V_{GS} = 10V, I_{D} = 20A$	
Static Dialii-Source Off-Nesistance	Rds(on)	_	4.4	5.7	11122	V _G S = 6V, I _D = 20A	
Diode Forward Voltage	V _{SD}		0.8	1.2	V	V _G S = 0V, I _S = 20A	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		4209			V _{DS} = 40V, V _{GS} = 0V, f = 1MHz	
Output Capacitance	Coss		1513	_	pF		
Reverse Transfer Capacitance	Crss	_	62	_			
Gate Resistance	Rg		2.2	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (VGS = 6V)	Qg	_	41	_			
Total Gate Charge (V _{GS} = 10V)	Q_g	_	63	_	nC	V _{DS} = 40V. I _D = 20A	
Gate-Source Charge	Qgs	_	17	_	IIC	VDS = 40V, ID = 20A	
Gate-Drain Charge	Q_{gd}	_	16	_			
Turn-On Delay Time	td(ON)	_	16	_		$V_{DD} = 40V$, $V_{GS} = 10V$, $I_{D} = 20A$, $R_{G} = 6\Omega$	
Turn-On Rise Time	tr	_	24	_			
Turn-Off Delay Time	tD(OFF)		53	_	ns		
Turn-Off Fall Time	tF		31	_			
Body Diode Reverse Recovery Time	t _{RR}		56	_	ns	1- 204 di/dt 1004/us	
Body Diode Reverse Recovery Charge	Qrr	-	100	_	nC	I _S = 20A, di/dt = 100A/μs	

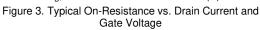
5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided. Notes:

- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1inch square copper plate. 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_{J} = +25^{\circ}C$.
- 9. Short duration pulse test used to minimize self-heating effect.
- Guaranteed by design. Not subject to product testing.
 Package limited.









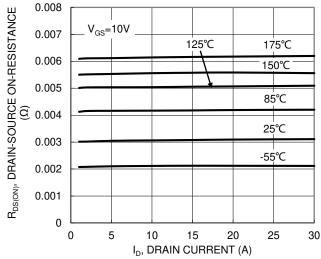
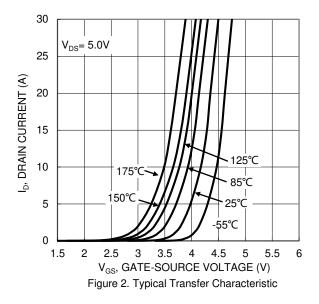
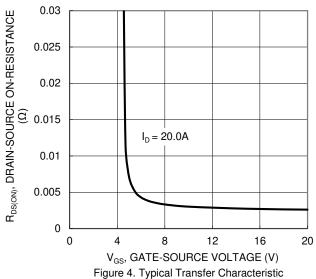


Figure 5. Typical On-Resistance vs. Drain Current and Temperature





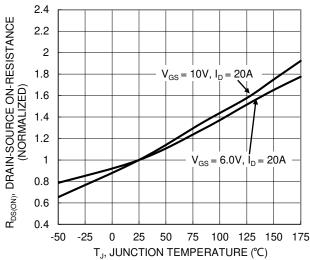


Figure 6. On-Resistance Variation with Temperature





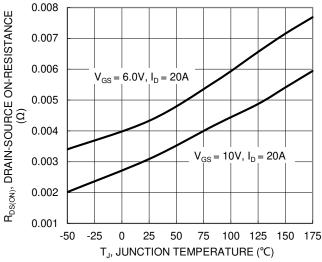
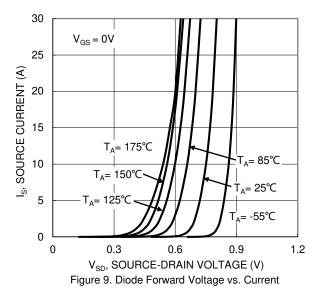
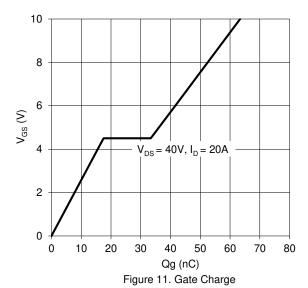
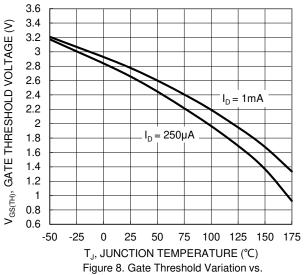


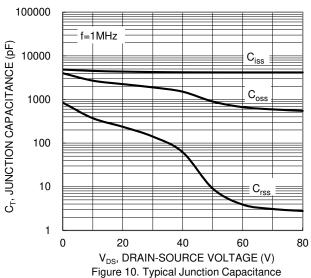
Figure 7. On-Resistance Variation with Temperature







JunctionTemperature



1000 100 ID, DRAIN CURRENT (A) 10 100µs $T_{J(MAX)}=175$ °C T_C=25°C 0.1 Single Pulse DUT on infinite heatsink V_{GS}=10V 0.01 0.1 100 V_{DS} , DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area

December 2019

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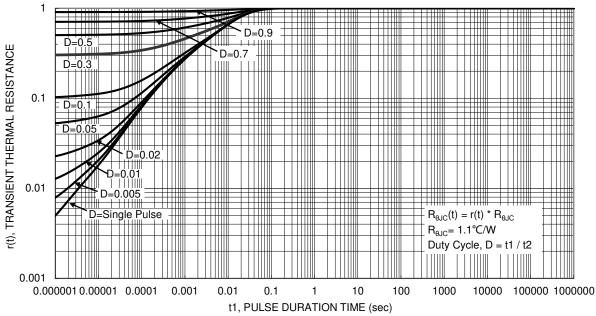


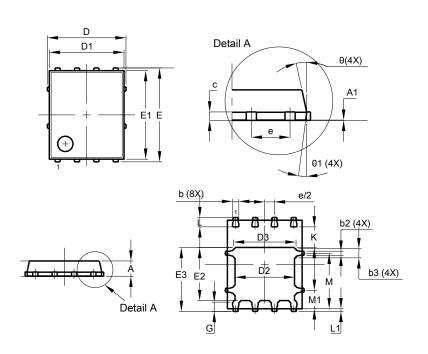
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8

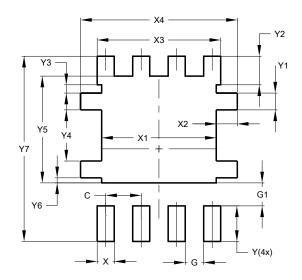


PowerDI5060-8				
Dim	Min	Max	Тур	
A	0.90	1.10	1.00	
A1	0.00	0.05	-	
b	0.33	0.51	0.41	
b2	0.200	0.350	0.273	
b3	0.40	0.80	0.60	
С	0.230	0.330	0.277	
C D		5.15 BSC		
D1	4.70	5.10	4.90	
D2	3.70	4.10	3.90	
D3	3.90	4.30	4.10	
E	(3.15 BSC	;	
E1	5.60	6.00	5.80	
E2	3.28	3.68	3.48	
E3	3.99	4.39	4.19	
е		1.27 BSC		
G	0.51	0.71	0.61	
K	0.51	-	-	
L	0.51	0.71	0.61	
L1	0.100	0.200	0.175	
M	3.235	4.035	3.635	
M1	1.00	1.40	1.21	
Θ	10°	12°	11°	
Θ1	6°	8°	7°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI5060-8



Dimensions	Value (in mm)			
С	1.270			
G	0.660			
G1	0.820			
X	0.610			
X1	4.100			
X2	0.755			
Х3	4.420			
X4	5.610			
Υ	1.270			
Y1	0.600			
Y2	1.020			
Y3	0.295			
Y4	1.825			
Y5	3.810			
Y6	0.180			
Y7	6.610			



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